





20V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BVDSS	Rds(on) max	Package	ID MAX TA = +25°C
20V	11.6mΩ @ V _{GS} = 4.5V	U-DFN2020-6	10.5A
200	15mΩ @ V _{GS} = 2.5V	(Type E)	9.4A

Description

This new generation MOSFET is designed to minimize the on-state resistance ($R_{\rm DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

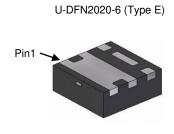
- General Purpose Interfacing Switch
- Power Management Functions

Features

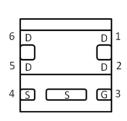
- 0.6mm Profile Ideal for Low Profile Applications
- PCB Footprint of 4mm²
- Low Gate Threshold Voltage
- Low On-Resistance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

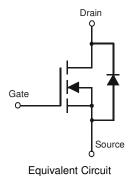
- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.0065 grams (Approximate)



Bottom View



Bottom View Pin Out



Ordering Information (Note 4)

Part Number	Marking	Reel Size (inches)	Quantity per Reel
DMN2015UFDE-7	N4	7	3,000
DMN2015UFDE-13	N4	13	10,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

Site 1



N4 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code Key

Year	2011		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	Υ		Н		J	K	L	М	N	0	Р	R
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Site 2



N4 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 0 = 2020) W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Key

Year	2011	 2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	1	 0	1	2	3	4	5	6	7	8	9

Week	1-26	27-52	53
Code	A-Z	a-z	Z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	T	U	V	W	X	Υ	Z



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V_{DSS}	20	V
Gate-Source Voltage			Vgss	±12	V
Continuous Dusin Courset (Note C) Vo. 4 5V	Steady State	T _A = +25°C T _A = +70°C	l _D	10.5 8.5	Α
f<108 ''		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	lo	12.5 10.0	А
Continuous Drain Current (Note 6) $V_{GS} = 2.5V$ Steady $T_{A} = +25^{\circ}$ State $T_{A} = +70^{\circ}$ $T_{A} = +25^{\circ}$		T _A = +25°C T _A = +70°C	lo	9.4 7.5	Α
		T _A = +25°C T _A = +70°C	lo	11.2 8.8	А
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%	I_{DM}	80	Α		
Maximum Body Diode Continuous Current			Is	2.5	Α

Thermal Characteristics

Characteristic		Symbol	Value	Unit	
Total Bower Discinction (Note 5)	T _A = +25°C	D-	0.66	W	
Total Power Dissipation (Note 5)	T _A = +70°C	P_D	0.42	VV	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	р	189	°C/W	
Internal Resistance, Junction to Ambient (Note 3)	t<10s	$R_{\theta JA}$	132		
Total Bower Dissination (Note 6)	T _A = +25°C	D-	2.03	W	
Total Power Dissipation (Note 6)	$T_A = +70$ °C	PD	1.31	VV	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	р	61		
Internal nesistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	43	°C/W	
Thermal Resistance, Junction to Case (Note 6)		R _θ JC	9.3		
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	20	-	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	-	_	1	μΑ	$V_{DS} = 16V$, $V_{GS} = 0V$	
Gate-Source Leakage	IGSS		_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	0.5	_	1.1	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
			9.3	11.6		$V_{GS} = 4.5V, I_{D} = 8.5A$	
Static Drain-Source On-Resistance	Dag (a)		11.4	15	mΩ	$V_{GS} = 2.5V, I_{D} = 8.5A$	
Static Diani-Source On-nesistance	R _{DS(ON)}	_	17	30	1112.2	$V_{GS} = 1.8V, I_{D} = 5A$	
			24	50		$V_{GS} = 1.5V, I_{D} = 3A$	
Forward Transfer Admittance	Y _{fs}	_	11.3	_	S	$V_{DS} = 10V, I_D = 8.5A$	
Diode Forward Voltage	V _{SD}	_	-	1.2	V	$V_{GS} = 0V, I_{S} = 8.5A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	I	1779		pF	V 40V V 0V	
Output Capacitance	Coss	1	175	_	pF	V _{DS} = 10V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss		154	_	рF	1 = 1.0WH12	
Gate Resistance	Rg	_	0.94	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g	-	19.7	_	nC		
Total Gate Charge (V _{GS} = 10V)	Qg	_	45.6	_	nC	V 10V I- 0.5A	
Gate-Source Charge	Qgs	_	2.9	_	nC	$V_{DS} = 10V, I_{D} = 8.5A$	
Gate-Drain Charge	Q _{gd}	_	3.8	_	nC		
Turn-On Delay Time	tD(on)		7.4	_	ns		
Turn-On Rise Time	tr	_	16.8	_	ns	V _{DS} = 10V, I _D = 8.5A	
Turn-Off Delay Time	tD(off)		43.6	_	ns	$V_{GS} = 4.5V, R_{G} = 1.8\Omega$	
Turn-Off Fall Time	tf		10.9	_	ns	1	
Reverse Recovery Time	T _{rr}		8.6	_	ns	0.54 41/44 0404/44	
Reverse Recovery Charge	Qrr	_	3.7	_	nC	I _F = 8.5A, di/dt = 210A/μs	

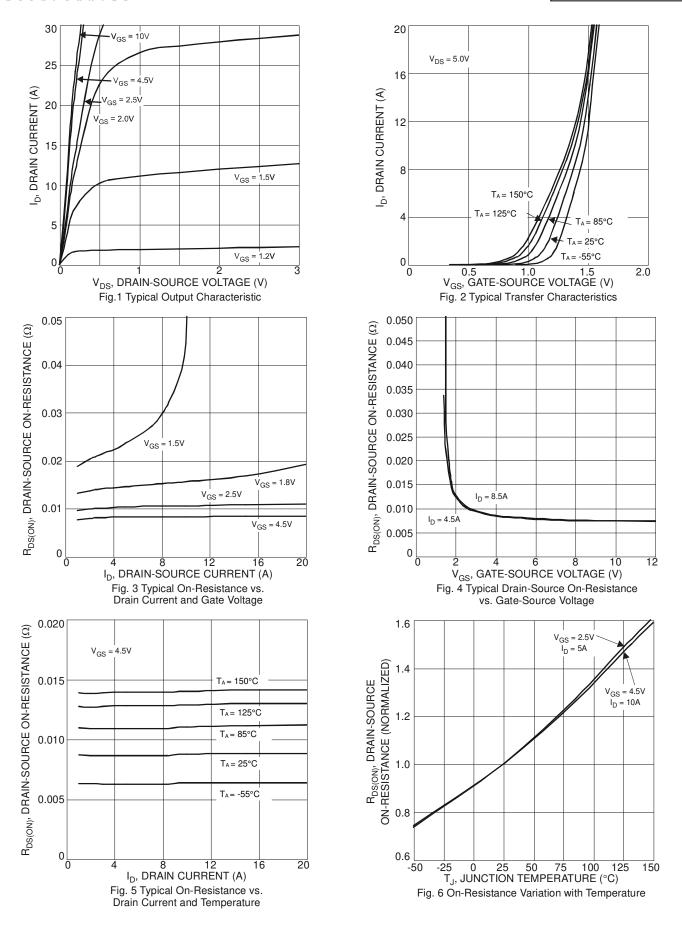
Notes: 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

^{6.} Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

^{7.} Short duration pulse test used to minimize self-heating effect.

^{8.} Guaranteed by design. Not subject to production testing.







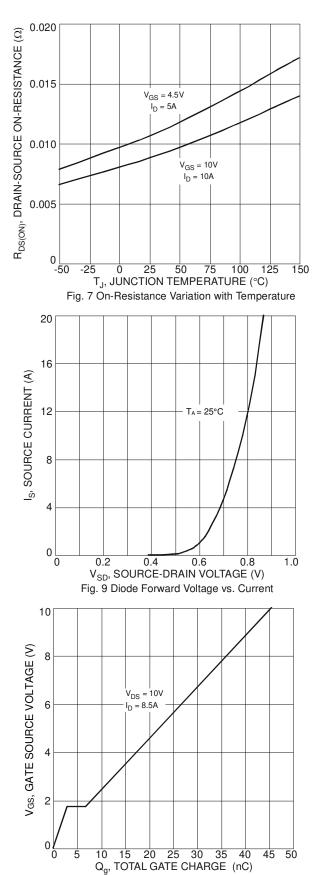
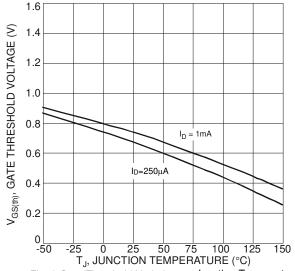
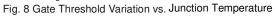
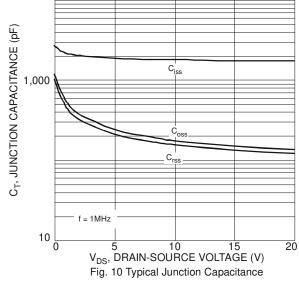
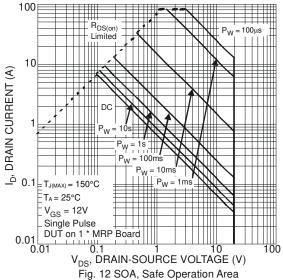


Fig. 11 Gate Charge

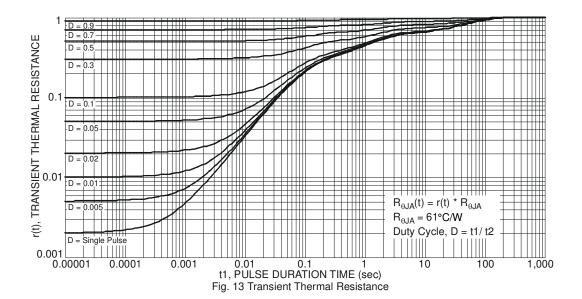










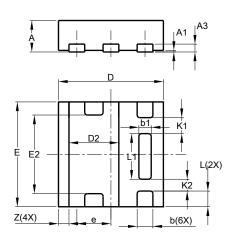




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type E)

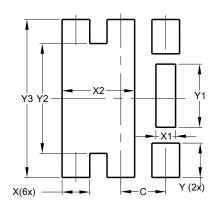


U-DFN2020-6								
Type E								
Dim	Min	Тур						
Α	0.57	0.63	0.60					
A1	0	0.05	0.03					
A3	-	-	0.15					
b	0.25	0.35	0.30					
b1	0.185	0.285	0.235					
D	1.95	2.05	2.00					
D2	2 0.85 1.05		0.95					
E	1.95	2.05	2.00					
E2	1.40	1.60	1.50					
е	_	_	0.65					
L	0.25	0.35	0.30					
L1	0.82	0.92	0.87					
K1	-	_	0.305					
K2	_	_	0.225					
Z	-	_	0.20					
All	Dimen	sions i	in mm					

Suggested Pad Layout

 $Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$

U-DFN2020-6 (Type E)



Dimensions	value (in mm)
С	0.650
Х	0.400
X1	0.285
X2	1.050
Y	0.500
Y1	0.920
Y2	1.600
Y3	2.300



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